Vishay General Semiconductor

Ultrafast Avalanche Surface Mount Rectifiers



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LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2.0 A				
V _{RRM}	800 V, 1000 V				
I _{FSM}	30 A				
t _{rr}	75 ns				
E _{AS}	20 mJ				
V_F at I_F = 2.0 A	1.42 V				
T _J max.	175 °C				
Package	SMPC (TO-277A)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Glass passivated pellet chip junction
- Fast reverse recovery time
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in lighting, fast switching rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER		SYMBOL	AU2PK	AU2PM	UNIT	
Device marking code			AU2K	AU2M		
Maximum repetitive peak reverse voltage		V _{RRM}	800	1000	V	
Maximum DC forward current (fig. 1)		I _F ⁽¹⁾	2.0		Α	
		I _F ⁽²⁾	1.3		A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load		I _{FSM}	30		А	
Non-repetitive avalanche energy at $T_J = 25 \ ^\circ C$	$I_{AS} = 2.5 \text{ A max}.$	Е	20		mJ	
	I _{AS} = 1.0 A typ.	E _{AS}	30		IIIJ	
Operating junction and storage temperature range		T _J , T _{STG}	-55 to +175		°C	

Notes

⁽¹⁾ Mounted on 10 mm x 10 mm pad areas, 1 oz. FR4 PCB

⁽²⁾ Free air, mounted on recommended pad area

Revision: 01-Apr-2020

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Document Number: 89337

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RoHS

COMPLIANT



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.0 A	T _A = 25 °C	V _F ⁽¹⁾	2.1	2.5	V
		T _A = 125 °C		1.42	2.0	
Reverse current	Rated V_R	T _A = 25 °C	I _R ⁽²⁾	0.27	10	μA
		T _A = 125 °C		62	500	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	50	75	ns
Typical junction capacitance per diode	Rated V _R = 4.0 V, 1 MHz		CJ	29	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 $\,\%$ duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	AU2PK AU2PM		UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾	85		°C/W	
	R _{0JM} ⁽²⁾	5			

Notes

 $^{(1)}\,$ Free air, mounted on recommended PCB 1 oz. pad are; thermal resistance $R_{\theta JA}$ - junction to ambient

 $^{(2)}$ Units mounted on PCB with 10 mm x 10 mm copper pad areas; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
AU2PM-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel		
AU2PM-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel		
AU2PMHM3_A/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel		
AU2PMHM3_A/I ⁽¹⁾	0.10	I	6500	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

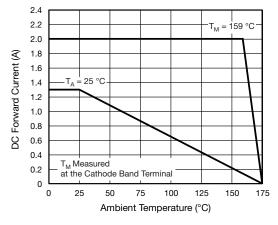


Fig. 1 - Maximum Forward Current Derating Curve

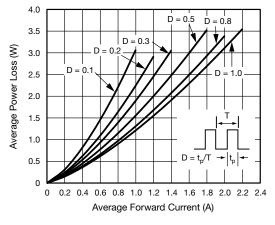


Fig. 2 - Average Power Loss Characteristics

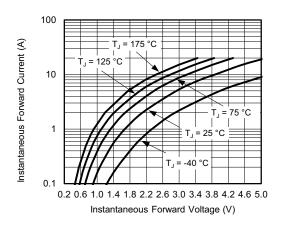


Fig. 3 - Typical Instantaneous Forward Characteristics

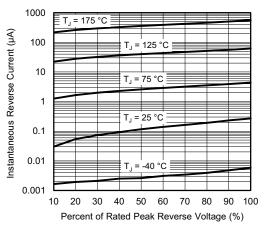


Fig. 4 - Typical Reverse Leakage Characteristics

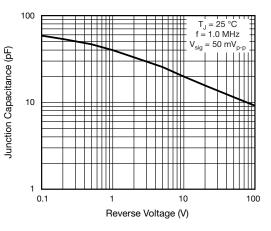
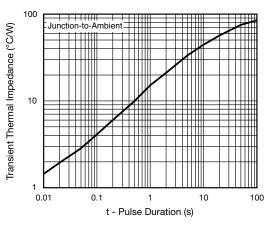


Fig. 5 - Typical Junction Capacitance





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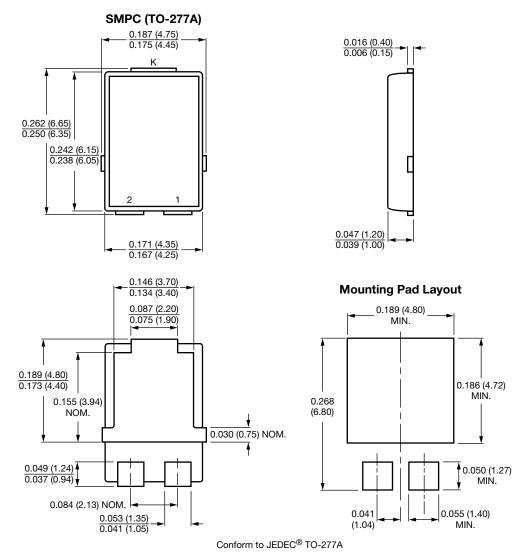
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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